Herschel/SPIRE

SPIRE-MSS-PRJ-001021

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SPIRE – STRUCTURE DECLARED PROCESSESS LIST Document Number: MSSL/SPIRE/PA004.03 January 2003

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0.1		September 2001	New document
2		22 November 2002	Issued
3		January 2003	Updated with Silver Soldering

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Glossary

All terms are listed in the CIDL.

1 Scope of Document

This document presents all the processes to be used all along the design, development and manufacture of the structure for SPIRE.

2. Applicable and Reference Documents

All documents are listed in Figure 3.2 of the CIDL.

3 Declared Processes List

The Structure Declared Processes List, which consists of multiple arrays of 10 columns which shall be completed as indicated in AD04, is presented here below:

Processes should be grouped in the table below:

Group Type	Used
1. Adhesive Bonding	\checkmark
2. Composite Manufacturing	N/A
3. Encapsulation/Molding	N/A
4. Painting/Coating	\checkmark
5. Cleaning	\checkmark
6. Welding/Brazing	\checkmark
7. Crimping/Stripping/Wire Wrapping	\checkmark
8. Soldering	N/A
9. Surface Treatment	N/A
10. Plating (Allo-chroming)	\checkmark
11. Machining	\checkmark
12. Forming	\checkmark
13. Heat Treatment	\checkmark
14. Special Fabrication	N/A
15. Marking	\checkmark
16. Miscellaneous Processes	N/A
17. Inspection Procedure	\checkmark

PROJ EXPE	e No 3 I <u>ECT:</u> ERIMENT: ERIMENTERS:	HERSCHE SPIRE MULLAR	DECLARED PROCESSES LIST EL RD SPACE SCIENCE LABORATORY (MSSL)						
PREF	PARED BY:	C Brockley	-Blatt						
Itm No	Process	Specificat	tion Description/ identification	Use and location	User code	Associated DML items	Criticality of process	Approval Status	ESA Comments
1.	Scotch Weld 1838	Commercial 2 epoxy adhesiv			MSSL	10-01	Non-critical		
2.	Stycast 2850 FT Black	Commercial 2 epoxy adhesiv cryogenics		Internal and external wiring harness supports	MSSL	10-02	Non-critical		
3.	Chemglaze Z 306, L300 & Z307	ECSS-Q-70-2 MSSL/ME/PS	-	Finish on main structure	CYF & SNL	01-01,02, 01-03, 12-04	Non-critical		
5.	Crimp connections	ECSS-Q-70-2	6 Fabrication of wiring harnesses	Internal and external wiring harnesses	MSSL	19-01	Non-critical		
6.	Alocrom 1200	MOD 03-18	Chromating - Commercial process	Various	MSSL	01-01,02, 01-03	Non-critical		

PROJ EXPI EXPI	Issue No 3 DECLARED PROCESSES LIST PROJECT: HERSCHEL EXPERIMENT: SPIRE EXPERIMENTERS: MULLARD SPACE SCIENCE LABORATORY (MSSL) PREPARED BY: C Brockley-Blatt								
Itm No	Process	Specificati	on Description/ identification	Use and location	User code	Associated DML	Criticalit of proces		ESA Comments
7.	Anodising	DEF STAN 03	24 Chromic acid process	Gear - dichroic assembly	I & G	01-03 12-02	Non-critical		
8.	Heat Treatment T 73	Mil-H-6088-F	Thermal treatment	Treatment for aluminium	SNL	01-01	Non-critical		
9	Silver Soldering	MSSL In-Hous Procedure	se Brazing using a 55% silver solder (rest is zinc, copper and Tin)	Thermal joints on the thermal bus bar	MSSL	07-01	Non-critical		